DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TRENCH STRUCTURE AND METHOD OF FORMING THE SAME

he specification of which is attached here	to unless the following box is checked:			
was filed on and wa	as United Sta	_ as United States Application Number or PCT International Application Number (if applicable).		
I hereby state that I have reviewed and amendment referred to above.	understand the contents of the above-	identified specification, including the claims	, as amended by any	
acknowledge the duty to disclose information 1.56.	ation which is known by me to be materia	al to patentability as defined in Title 37, Code of	f Federal Regulations	
certificate, or § 365(a) of any PCT Interna	ational application which designated at least on for patent or inventor's certificate, or)-(d) or § 365(b) of any foreign application(s) feast one country other than the United States, PCT International application having a filing	listed below and have	
NUMBER	COUNTRY	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED	
2002-48978	Republic of Korea	19/August/2002	Yes	
hereby claim the benefit under Title 35,	United States Code § 119(e) of any Unit	ed States provisional application(s) listed belo	w.	
APPLICAT	FION NO.	FILING DATE		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

APPLICATION SERIAL NO.	FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Eugene M. Lee, Reg. No. 32,039; Richard A. Sterba, Reg. No. 43,162.

Address all correspondence to Eugene M. Lee, LEE & STERBA, PC, 1101 Wilson Boulevard, Suite 2000, Arlington, Virginia 22209. Address all telephone communications to Eugene M. Lee at (703) 525-0978.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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